

## Bundled conductors

### Corona

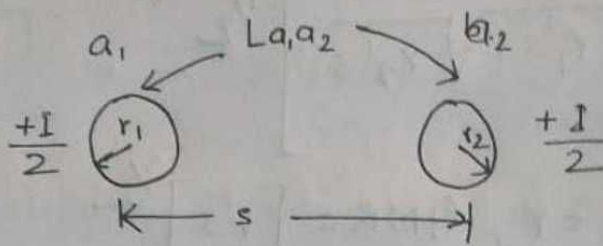
- ⇒ Electric field on surface of conductor is greater than dielectric strength then air around the conductor ionizes.
- ⇒ Due to corona there is hissing sound and purple glow around the conductor.
- ⇒ Due to light and sound the energy is dissipated called as corona loss.

### Reducing Corona

- ⇒ To Reduce corona loss, we need to reduce the electric field which can be done by following methods —
  - ⇒ Reduce operating voltage
  - ⇒ Increase GMD and GMR.
- ⇒ Increasing GMD requires increasing distance between conductors which requires increasing the size of tower and hence increasing the cost.
- ⇒ Increasing GMR implies increasing effective radius so that electric field reduces.

## Bundle Conductor

- one conductor is replaced by a group of conductors kept at certain distance



$$\begin{aligned}\lambda_{a_1} &= \frac{\mu_0 I}{2\pi} \frac{1}{2} \ln \frac{1}{r_1'} + \frac{\mu_0 I}{2\pi} \frac{1}{2} \ln \frac{1}{s} \\ &= \frac{\mu_0 I}{2\pi} \ln \frac{1}{\sqrt{r_1' s}}\end{aligned}$$

even mutual flux b/w  $a_1$  &  $a_2$  acts as self flux because both conductor belongs to same phase.

$$\left. \begin{array}{l} \rightarrow \text{solid conductor self } \rightarrow r_1' \\ \rightarrow \text{bundled conductor self } \sqrt{r_1' s} \\ \sqrt{r_1' s} > r_1' \quad \text{GMR} \uparrow \end{array} \right\}$$

$$\begin{aligned}\lambda_{a_2} &= \frac{\mu_0 I}{2\pi} \frac{1}{2} \ln \frac{1}{s} + \frac{\mu_0 I}{2\pi} \frac{1}{2} \ln \frac{1}{r_2'} \\ &= \frac{\mu_0 I}{2\pi} \ln \frac{1}{\sqrt{r_2' s}}\end{aligned}$$

Again in flux linkage

$r_2'$  is replaced by  $\sqrt{r_2' s}$

so, GMR  $\uparrow$

## Overall GMR

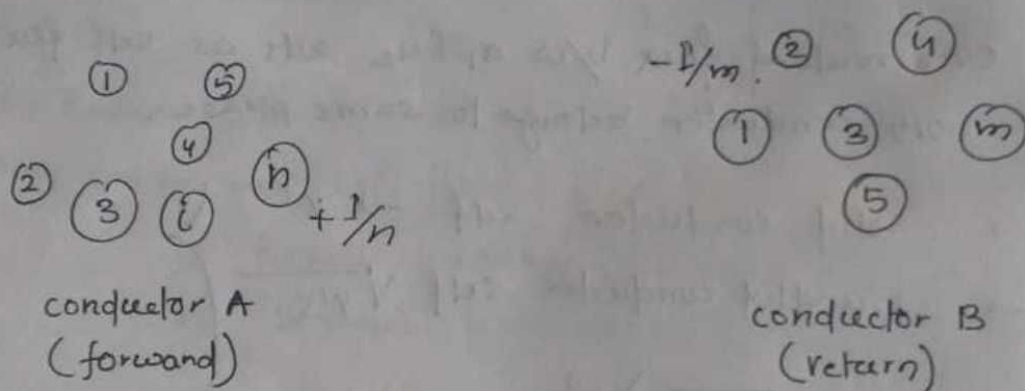
$$GMR = \left[ (GMR)_1 (GMR)_2 \right]^{1/2}$$

$$= \left[ \sqrt{r_1's} \sqrt{r_2's} \right]^{1/2}$$

$$\text{if } r_1 = r_2 = r, GMR = [r's]^{1/2}$$

↓ self GMD.

## Inductance of Bundled conductor



$$\lambda_i = \sum_{j=1}^n \frac{\mu_0 I_j}{2\pi} \ln \frac{1}{D_{ij}} + \sum_{k=1}^m \frac{\mu_0 I_k}{2\pi} \ln \frac{1}{D_{ik}}$$

$$= \frac{\mu_0 I}{2\pi n} \sum_{j=1}^n \ln \frac{1}{D_{ij}} - \frac{\mu_0 I}{2\pi m} \sum_{k=1}^m \ln \frac{1}{D_{ik}}$$

$$= \frac{\mu_0 I}{2\pi} \left[ \sum_{j=1}^n \ln \frac{1}{(D_{ij})^{1/n}} - \sum_{k=1}^m \ln \frac{1}{(D_{ik})^{1/m}} \right]$$

$$= \frac{\mu_0 I}{2\pi} \left[ \ln \frac{1}{(D_{i1} D_{i2} \dots D_{in})^{1/n}} - \ln \frac{1}{(D_{i1}' D_{i2}' \dots D_{im}')^{1/m}} \right]$$

$$\lambda_i = \frac{\mu_0 \rho}{2\pi} \left[ \ln \frac{(D_{i1}' D_{i2}' \dots D_{im}')^{1/m}}{(D_{i1} D_{i2} \dots D_{in})^{1/n}} \right]$$

$$L_{i2} \frac{\lambda_i}{\rho_i} = \frac{\lambda}{\rho/n} = \frac{n \rho_i}{\rho}$$

$$= \frac{\mu_0 n}{2\pi} \ln \left[ \frac{(D_{i1}' D_{i2}' D_{i3}' \dots D_{im}')^{1/m}}{(D_{i1} D_{i2} \dots D_{in})^{1/n}} \right]$$

$$L_{avg} = \frac{\sum_{i=1}^n L_i}{n} = \sum_{i=1}^n \frac{\mu_0}{2\pi} \ln \left[ \frac{(D_{i1}' D_{i2}' \dots D_{im}')^{1/m}}{(D_{i1} D_{i2} \dots D_{in})^{1/n}} \right]$$

$$L_{avg} = \frac{\mu_0}{2\pi} \ln \left[ \frac{\prod_{i=1}^n (D_{i1}' \dots D_{im}')^{1/m}}{\prod_{i=1}^n (D_{i1} D_{i2} \dots D_{in})^{1/n}} \right]$$

$$L_f = \frac{L_{avg}}{n} \quad (\text{due to parallel connection})$$

$$L_f = \frac{\mu_0}{2\pi n} \ln \left[ \frac{\prod_{i=1}^n (D_{i1}' D_{i2}' \dots D_{im}')^{1/m}}{\prod_{i=1}^n (D_{i1} D_{i2} \dots D_{in})^{1/n}} \right]$$

$$= \frac{\mu_0}{2\pi} \ln \left[ \frac{\left\{ (D_{11}' D_{12}' \dots D_{1m}') (D_{21}' D_{22}' \dots D_{2m}') \dots (D_{n1}' D_{n2}' \dots D_{nm}') \right\}^{1/n}}{\left\{ (D_{11} D_{12} \dots D_{1n}) (D_{21} D_{22} \dots D_{2n}) \dots (D_{n1} D_{n2} \dots D_{nn}) \right\}^{1/n^2}} \right]$$

$$L_f = \frac{\mu_0}{2\pi} \ln \frac{D_m}{D_{sf}}$$

$$L_r = \frac{\mu_0}{2\pi} \ln \frac{D_m}{D_{sr}}$$

$D_{sr}$  self GMD (return)

$D_m$  = mutual GMD

$D_{sf}$  = self GMD (forward path)

## Advantages

- Electric field decreases so corona loss reduces and hence efficiency increases.
- Inductance of Bundled conductors is less than solid conductor.
- Capacitance of Bundled conductor is more than solid conductor.
- Due to increase in capacitance per phase, power factor of system increases

$$\rightarrow L_b = \frac{\mu_0}{2\pi} \ln \frac{D_m}{D_s} \quad L_s = \frac{\mu_0}{2\pi} \ln \frac{D_m}{r'}$$

$$\therefore (\text{self GMD } (D_s) > r')$$

$$L_b < L_s$$

$$C_b = \frac{2\pi\epsilon_0}{\ln D_m/D_s}, \quad C_s = \frac{2\pi\epsilon_0}{\ln D_m/r}$$

$$D_s > r \quad ; \quad C_b > C_s$$

$$C \uparrow \quad L \downarrow$$

$\Rightarrow$  Due to reduction in inductance per phase the reactance of transmission line reduces and hence voltage drop reduces.

⇒ Due to reduction in reactance, maximum power transfer increases and hence stability improves.

$$P_{max} = \frac{V_s V_R}{X} \quad \text{as } X \downarrow \quad P_{max} \uparrow$$

stability  $\propto$   $P_{max}$ .

⇒ Surge impedance Reduces and SIL increases

$$Z_s = \sqrt{\frac{L}{C}} \downarrow$$

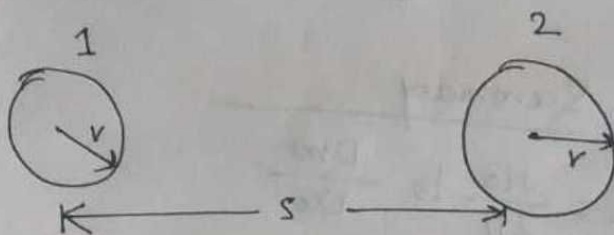
$$SIL = \frac{V^2}{Z_s} \uparrow$$

SIL = Surge impedance loading  $\frac{V^2}{Z_s}$ .

⇒ Radio interference reduces.

( $L \downarrow$ ,  $\lambda \downarrow$ , interference  $\downarrow$ )

Self GMD



$$D_s = \left[ (D_{11} D_{12}) (D_{21} D_{22}) \right]^{1/4}$$

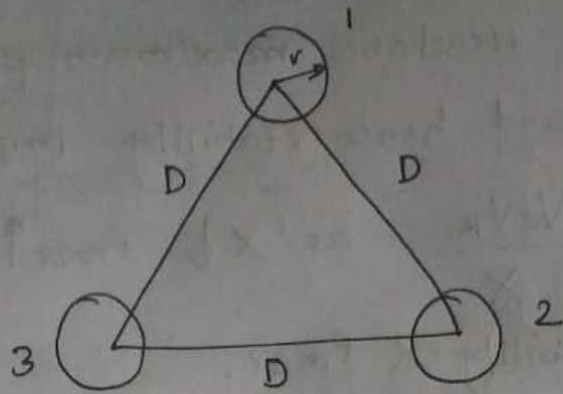
$$= \left[ (r' \times s) (s \times r') \right]^{1/4}$$

$$= [r' s]^{1/2}$$

Therefore consider only 1 of 2 conduct<sup>r</sup>

$$D_s = [D_{11} D_{12}]^{1/2}$$

$$= [r' s]^{1/2}$$



$$D_s = \left[ \begin{matrix} (D_{12} D_{13} D_{11}) & (D_{21} D_{22} D_{23}) & (D_{31} D_{32} D_{33}) \end{matrix} \right]^{1/9}$$

$$= \left[ (r' \times D \times D) (D \times r' \times D) (D \times D \times r') \right]^{1/9}$$

$$= \left[ (r')^3 (D)^6 \right]^{1/9} = \left[ r' \times D \times D \right]^{1/3}$$

OR.

Consider only 1.

$$D_s = \left[ D_{11} D_{12} D_{13} \right]^{1/3}$$

$$= \left[ r' \times D \times D \right]^{1/3}$$

Note:

- 2. Conductor line
- 3 conductor eq.  $\Delta$
- 4 conductor square
- 5. Conductor regular polygon.

### Summary

$$L = \frac{\mu_0}{2\pi} \ln \frac{D_m}{D_s}$$

$D_m =$  mutual GMD

$D_s =$  self GMD

- for conductors at corners of regular polygon self GMD of one conductor is same as entire system.